

Innovating Energy Technology

6MBP15XSD060-50

IGBT Modules

IGBT MODULE (X series) 600V / 15A / IPM

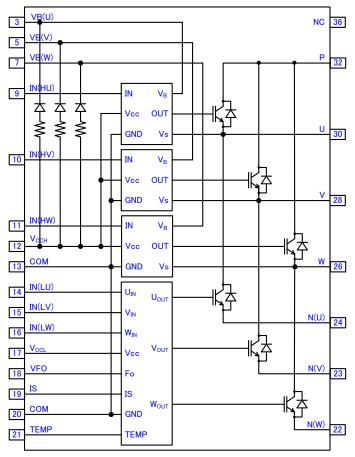
Features

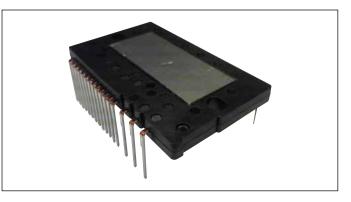
Low-side IGBTs are separate emitter type Short circuit protection Temperature sensor output function Under voltage protection Fault signal output function Input interface : TTL (3.3V/5V) Active high logic

Applications

AC 100 ~ 240V three phase inverter drive for small power AC motor drives (such as compressor motor drive for air conditioner, compressor motor drive for heat pump applications, fan motor drive, ventilator motor drive)

Terminal assign and Internal circuit





Pin No.	Pin Name	Pin Description
3	VB(U)	High-side bias voltage for U-phase IGBT driving
5	VB(V)	High-side bias voltage for V-phase IGBT driving
7	VB(W)	High-side bias voltage for W-phase IGBT driving
9	IN(HU)	Signal input for high side U-phase
10	IN(HV)	Signal input for high side V-phase
11	IN(HW)	Signal input for high side W-phase
12	Vссн	High-side control supply
13	СОМ	Common supply ground
14	IN(LU)	Signal input for low side U-phase
15	IN(LV)	Signal input for low side V-phase
16	IN(LW)	Signal input for low side W-phase
17	VCCL	Low-side control supply
18	VFO	Fault output
19	IS	Over current sensing voltage input
20	СОМ	Common supply ground
21	TEMP	Temperature sensor output
22	N(W)	Negative bus voltage input for W-phase
23	N(V)	Negative bus voltage input for V-phase
24	N(U)	Negative bus voltage input for U-phase
26	W	Motor W-phase output
28	V	Motor V-phase output
30	U	Motor U-phase output
32	Р	Positive bus voltage input
36	NC	No Connection

■ Absolute Maximum Ratings at Tj=25°C, Vcc=15V (unless otherwise specified)

Ite	ms	Symbol	Characteristics	Unit	Remarks
	DC Bus Voltage	VDC	450	V	Note *1
	Bus Voltage (Surge)	V _{DC(Surge)}	500	V	Note *1
	Collector-Emitter Voltage	VCES	600	V	
	Collector Current	C@25	15	A	Note *2
block	Peak Collector Current	CP@25	30	A	V _{cc} ≧15V, V _B (*)≧15V Note *2, *3, *4
nverter bl		ICP@25	20	A	Vcc≧13V, V₅(*)≧13V Note *2, *3, *4
Ž	Diode Forward current	F@25	15	A	Note *2
	Peak Diode Forward current	FP@25	30	A	Note *2
	Collector Power Dissipation	Pd_igbt	32.5	W	per single IGBT Tc=25°C
	FWD Power Dissipation	P _{D_FWD}	25.5	W	per single FWD Tc=25°C
	Junction Temperature	Tj	150	°C	
	Operating Junction Temperature	Tjop	-40 ~ +150	°C	
	High-side Supply Voltage	Vссн	-0.5 ~ 20	V	Applied between VCCH-COM
	Low-side Supply Voltage	VCCL	-0.5 ~ 20	V	Applied between V _{CCL} -COM
	High-side Bias Absolute Voltage	Vvb(u)-com Vvb(v)-com Vvb(w)-com	-0.5 ~ 620	V	Applied between VB(U)-COM, VB(V)-COM, VB(W)-COM
t block	High-side Bias Voltage for IGBT gate driving	$\begin{matrix} V_{B(U)} \\ V_{B(V)} \\ V_{B(W)} \end{matrix}$	-0.5 ~ 20	V	Note *4
	High-side Bias offset Voltage	Vu Vv Vw	-5 ~ 600	V	Applied between U-COM, V-COM, W-COM Note *5
Conti	Input Signal Voltage	Vin	-0.5 ~ V _{ссн} +0.5 -0.5 ~ V _{ссг} +0.5	V	Note *6
	Input Signal Current	lin	3	mA	sink current
	Fault Signal Voltage	VFO	-0.5 ~ V _{CCL} +0.5	V	Applied between V _F O-COM
	Fault Signal Current	Fo	1	mA	sink current
	Over Current sensing Input Voltage	Vis	-0.5 ~ V _{CCL} +0.5	V	Applied between IS-COM
	Junction Temperature	Tj	150	°C	
0	perating Case Temperature	Tc	-40 ~ +125	°C	See Fig.1-1
St	orage Temperature	Tstg	-40 ~ +125	°C	
ls	olation Voltage	Viso	AC 1500	Vrms	Sine wave,60Hz t=1min , Note *7

Note *1 : Applied between P-N(U),P-N(V),P-N(W) Note *2 : Pulse width and duty were limited by T_imax. Note *3 : Vcc is applied between VccH-COM,VccL-COM. Note *4 : V₆(*) is applied between VB(U)-U,VB(V)-V, VB(W)-W. Note *5 : Over 13.0V applied between VB(U)-U,VB(V)-V, VB(W)-W. This IPM module might make incorrect response if the high-side bias offset voltage is less than -5V.

Note *6 : Applied between IN(HU)-COM,IN(HV)-COM,IN(HW)-COM,IN(LU)-COM,IN(LV)-COM,IN(LW)-COM. Note *7 : Applied between shorted all terminal and IMS (Insulated Metal Substrate).

Electrical Characteristics

● Inverter block (Tj=25°C unless otherwise specified)

Description	Symbol	Conditions		min.	typ.	max.	Unit
Zero gate Voltage	ICES	V _{CE} = 600V	Tj=25°C	-	-	1	mA
Collector current	ICES	V _{IN} = 0V	T _j =125°C	-	-	10	mA
		V _{cc} =+15V	l₀=1.5A Tj=25°C	-	0.90	1.10	
Collector-Emitter saturation Voltage	V _{CE(sat)}	V _B (*)=+15V V _{IN} =5V	I₀=15A Tj=25°C	-	1.60	1.90	V
		Note *4	Ic=15A Tj=125°C	-	1.75	5 2.10	
FW/D Forward valtage drep	VF		T _j =25°C	-	1.60	1.90	v
FWD Forward voltage drop	VF		T _j =125°C	-	1.50	-	
Turn-on time	ton			0.55	0.90	1.30	
Turn-on delay	t _{d(on)}	V _{DC} =300V			0.75	-	
Turn-on rise time	tr	Ic=15A		-	0.15	-	
VCE-IC Cross time of turn-on	t _{c(on)}	Vcc=15V		-	0.35	0.60	
Turn-off time	toff	─ V _B (*)=15V ─ Ti=125°C		-	0.90	1.30	μs
Turn-off delay	t _{d(off)}	$V_{IN}=0V <-> 5V$		-	0.80	-	
Turn-off fall time	tr	See Fig.2-1		-	0.10	-	
VCE-IC Cross time of turn-on	t _{c(off)}	Note *4		-	0.15	0.30	
FWD Reverse Recovery time	trr			-	0.20	-	

• Control circuit block (Tj=25°C unless otherwise specified)

Description	Symbol	Conditions		min.	typ.	max.	Unit
Circuit current of Low-side		V _{CCL} =15V	V _{IN} =5V	-	0.6	0.9	
Circuit current of Low-side	ICCL	V _{CCL} =15V	V _{IN} =0V	-	0.6	0.9	mA
Circuit current of Link olde		V _{CCH} =15V	V _{IN} =5V	-	1.25	1.9	m 1
Circuit current of High-side	Іссн	V _{CCH} =15V	V _{IN} =0V	-	1.25	1.9	mA
Circuit current of Bootstrap circuit (per one uint)		$V_{B}(U)=15V,$	V _{IN} =5V	-	-	0.20	~^
	ССНВ	V _в (V)=15V, V _в (W)=15V	V _{IN} =0V	-	-	0.20	mA
Innut Cianal threadald valtage	Vth _(on)	Note *8 Pw≥0.9μs		-	2.1	2.6	V
Input Signal threshold voltage	Vth _(off)			0.8	1.3	-	V
Input Signal threshold hysteresis voltage	Vth _(hys)			0.35	0.80	-	V
Operational input pulse width of turn-on	tin(ON)	V _{IN} =0V to 5V rise up, Note *6, Note *8		0.5	-	-	μs
Operational input pulse width of turn-off	tin(OFF)	V _{IN} =5V to 0V fall down Note *6, Note *8		0.7	-	-	μs
Input current	lin	V _{IN} =5V, Note *6		0.7	1.0	1.5	mA
Input pull-down resistance	RIN	Note *6		3.3	5.0	7.2	kΩ
Fault Output Voltage	V _{FO(H)}	V_{IS} =0V, VFO terminal pull up to 5V by 10k Ω		4.9	-	-	V
	V _{FO(L)}	VIS=1V, IFO=1mA		-	-	0.95	V
Fault Output pulse width	t FO	Note *9, See Fig.2-2, 2-3		20	-	-	μs

Control circuit block (continued)

Over Current Protection Voltage Level	V _{IS(ref)}	V∞=15V → Note *3, *10 See Fig.2-2		0.455	0.48	0.505	V
Over Current Protection Delay time	td _(IS)			0.3	0.8	1.3	μs
	V	Note *11	Tc=90°C	2.63	2.77	2.91	V
Output Voltage of temperature sensor	V _(temp)	Note II	Tc=25°C	0.88	1.13	1.39	V
Vcc Under Voltage Trip Level of Low-side	VCCL(OFF)	T (7000		10.3	-	12.5	V
Vcc Under Voltage Reset Level of Low-side	V _{CCL(ON)}	— Tj<150°C — See Fig.2-3		10.8	-	13.0	V
Vcc Under Voltage hysteresis	V _{CCL(hys)}			-	0.5	-	V
Vcc Under Voltage Trip Level of High-side	VCCH(OFF)	— T∣<150°C — See Fig.2-4		8.3	-	10.3	V
Vcc Under Voltage Reset Level of High-side	V _{CCH(ON)}			8.8	-	10.8	V
Vcc Under Voltage hysteresis	V _{CCH(hys)}			-	0.5	-	V
VB Under Voltage Trip Level	V _{B(OFF)}			10.0	-	12.0	V
VB Under Voltage Reset Level	V _{B(ON)}	── Tj<150°C ── See Fig.2-5		10.5	-	12.5	V
VB Under Voltage hysteresis	V _{B(hys)}			-	0.5	-	V
Forward voltage of Bootstrap diode	V _{F(BSD)}	Т _j =25°С І _{F(BSD)} =10mА		0.90	1.4	1.90	V
	V _{F(BSD)}	T _j =25°C I _{F(BSD)} =100mA		2.3	4.3	6.3	V

Note *8 : This IPM module might make incorrect response if the input signal pulse width is less than t_{IN(on)} and t_{IN(off)}. Note *9: Fault signal is asserted corresponding to an "Over-current protection", an "Under-voltage protection" at low-side, and an "Over-heat protection". Under the condition of "Over-current protection" or "Under-voltage protection" or "Over-heat protection", the fault signal is asserted continuously while these conditions are continuing. However, the minimum fault output pulse width is minimum 20µsec even if very short failure condition (which is less than 20µa) is the transport. 20µs) is triggered.

Note *10: Over current protection is functioning only for the low-side arms. Note *11 : Fig.1-1 shows the measurement position of temperature sensor.

6MBP15XSD060-50

Thermal Characteristics

Description	Symbol	min.	typ.	max.	Unit
Junction to Case Thermal Resistance (per single IGBT) Note *12	Rth(j-c)_IGBT	-	-	3.85	°C/W
Junction to Case Thermal Resistance (per single FWD) Note *12	Rth((-c)_FWD	-	-	4.95	°C/W

Note *12: Thermal compound with good thermal conductivity should be applied evenly with about +100µm~+200µm on the contacting surface of this device and heatsink.

Mechanical Characteristics

Description	Symbol	Conditions	min.	typ.	max.	Unit
Tighten torque	-	Mounting screw: M3	0.59	0.69	0.98	Nm
Heat-sink side flatness	-	Note. *13	0	-	100	μm
Weight	-	-	-	9.3	-	g

Note *13: Fig.1-2 shows the measurement position of heat sink flatness

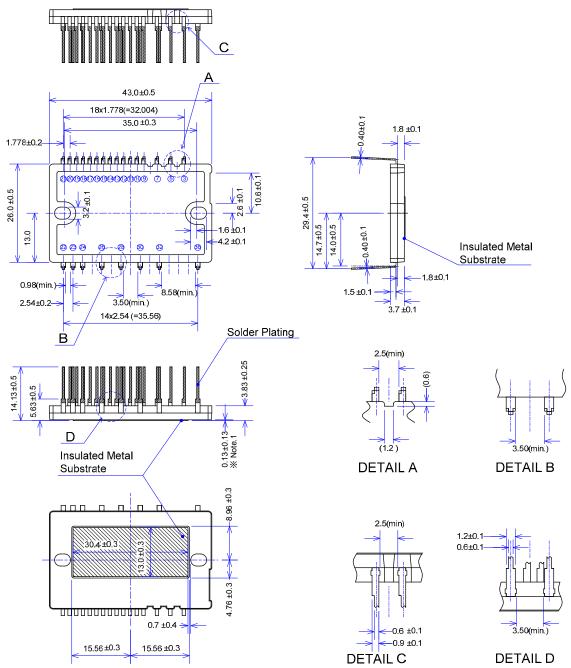
Recommended Operation Conditions

● All voltages are absolute voltages referenced to Vcc –potential unless otherwise specified.

Description	Conditions	min.	typ.	max.	Unit
DC Bus Voltage	VDC	0	300	400	V
High-side Bias Voltage for IGBT gate driving	V _B (*)	13.0	15.0	18.5	V
High-side Supply Voltage	Vссн	13.5	15.0	16.5	V
Low-side Supply Voltage	Vccl	13.5	15.0	16.5	V
Control Supply variation	ΔV _B	-1	-	1	1//00
Control Supply variation	ΔVcc	-1	-	1	V/µs
Input signal voltage	Vin	0	-	5	V
Voltage for current sensing	Visc	0	-	5	V
Potential difference of between COM to N (including surge)	V _{COM_N}	-5	-	5	V
Dead time for preventing arm-short (Tc≤125°C)	tDEAD	1.0	-	-	μs
Allowable output current (Note *14)	lo	-	-	15.0	A rms
Allowable minimum input pulse width	PW _{IN(on)}	0.5	-	-	μs
(Note *15, Note *16)	PW _{IN(off)}	0.7	-	-	μs
PWM Input frequency	f _{PWM}	-	-	20	kHz
Operating Junction Temperature	T _{j(ope)}	-30	-	150	°C

Note *14: V_{DC}=300V, V_{CCH}=V_{CCL}=V_B(*)=15V, PF=0.8, Sinusoidal PWM, 3phase modulation, Tj≤150°C, Tc≤100°C, f_{PWM}=5kHz, fo=200Hz, Ks=0.9 Note *15: In the pulse width of 0.5us, the loss of IGBT increases for the saturation operation. To reduce the loss of IGBT, please enlarge the pulse width more than the switching time of IGBT. Note *16: This IPM module might response according to input signal pulse even when the input signal pulse width is less than PW_{IN(or)} and PW_{IN(orf)}.

Package outline dimensions



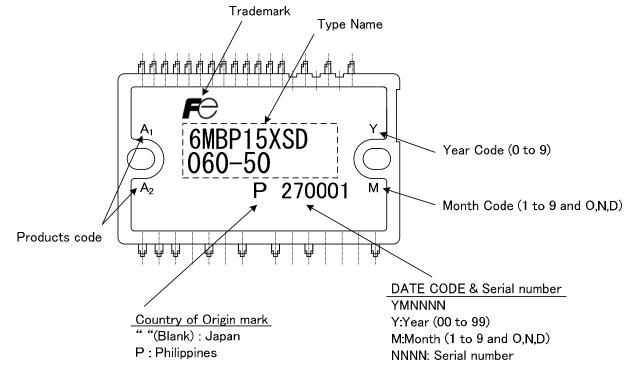
Unit: mm

Note %1: The IMS(Insulated Metal Substrate) deliberately protruded from back surface of case. It is improved of thermal conductivity between IMS and heat-sink.

Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin Name
3	VB(U)	14	IN(LU)	22	N(W)
5	VB(V)	15	IN(LV)	23	N(V)
7	VB(W)	16	IN(LW)	24	N(U)
9	IN(HU)	17	Vccl	26	W
10	IN(HV)	18	VFO	28	V
11	IN(HW)	19	IS	30	U
12	Vссн	20	COM	32	Р
13	COM	21	TEMP	36	NC

6MBP15XSD060-50

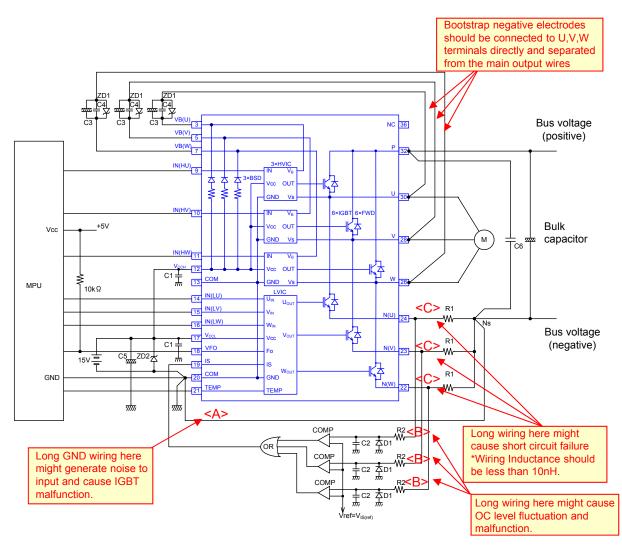
Marking



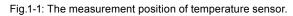
Note : Product code A_1 means current ratings , and "L" is marked. Product code A_2 means variations , and "D" is marked.

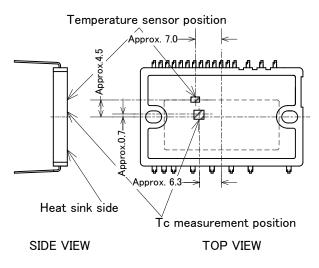
An example of application circuit.

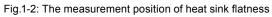
• Fig. shows an example of an application circuit.



- Note *1: Input signal for drive is High-Active. There is a pull-down resistor built in the IC input circuit. To prevent malfunction, the wiring of each input should be as short as possible. When using R-C coupling circuit, make sure the input signal level meet the turn-on and turn-off threshold voltage.
- Note *2: By the function of the HVIC, it is possible of the direct coupling to microprocessor (MPU) without any photo-coupler or pulse-transformer isolation.
- Note *3: VFO output is open drain type. It should be pulled up to the positive side of a 5V power supply by a resistor of about 10kΩ.
- Note *4: To prevent erroneous protection, the wiring of (A), (B), (C) should be as short as possible.
- Note *5: The time constant R2-C2 of the protection circuit should be selected approximately 1.5µs.
- Over current (OC) shutdown time might vary due to the wiring pattern. Tight tolerance, temp-compensated type is recommended for R2, C2.
- Note *6: Please set the threshold voltage of the comparator reference input to be same as the IPM OC trip reference voltage V_{IS(ref)}.
- Note *7: Please use high speed type comparator and logic IC to detect OC condition quickly.
- Note *8: If negative voltage of R1 at the switching timing is applied, the schottky barrier diode D1 is recommended to be inserted parallel to R1.
- Note *9: All capacitors should be mounted as close to the terminals of the IPM as possible. (C1, C4 : narrow temperature drift, higher frequency and DC bias characteristic ceramic type are recommended, and C3, C5: narrow temperature drift, higher frequency and electrolytic type.)
- *10: To prevent surge destruction, the wiring between the snubber capacitor and the P terminal ,Ns node should be as short as possible. Generally a 0.1µ to 0.22µF Note snubber capacitor (C6) between the P terminal and Ns node is recommended.
- Note *11: Two COM terminals (13 & 20 pin) are connected inside the IPM, it must be connected either one to the signal GND outside and leave another one open.
- Note *12: It is recommended to insert a zener-diode (22V) between each pair of control supply terminals to prevent surge destruction.
- Note *13: If signal GND is connected to power GND by broad pattern, it may cause malfunction by power GND fluctuation. It is recommended to connect signal GND and power GND at only a point.







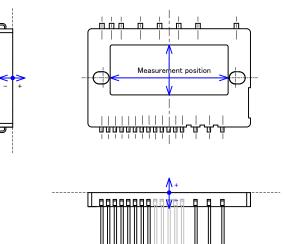
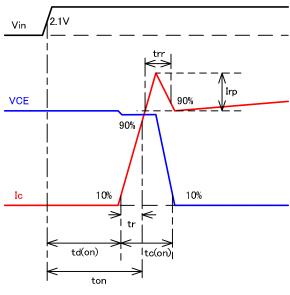


Fig.2-1: Switching waveforms



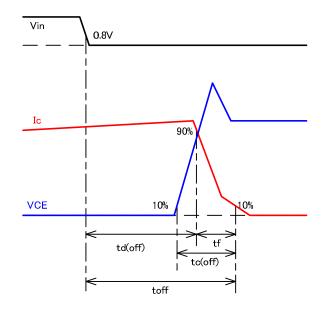
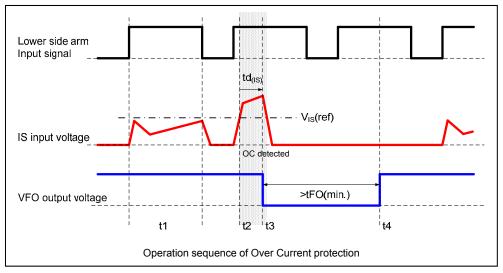


Fig.2-2: Operation sequence of Over current protection



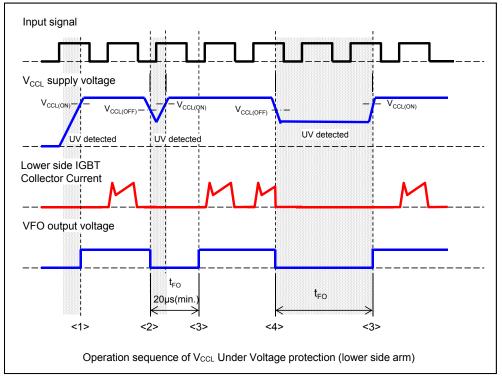
t1: IS input voltage does not exceed V_{IS} (ref), while the collector current of the lower side IGBT is under the normal operation.

t2: When IS input voltage exceeds Vis(ref), the OC is detected.

t3: The fault output VFO is activated and all lower side IGBT shut down simultaneously after the over current protection delay time td(15). Inherently there is dead time of LVIC in td(IS).

t4: After the fault output pulse width tFO, the OC is reset. Then next input signal is activated.

Fig.2-3: Operation sequence of $V_{\text{\tiny CCL}}$ Under voltage trip (lower side arm)



When VCCL is under 4V, UV and fault output are not activated.

<1> When VccL is under VccL(ON), all lower side IGBTs are OFF state.
 After VccL rises VccL(ON), the fault output VFO is released (high level).
 And the LVIC starts to operate, then next input is activated.

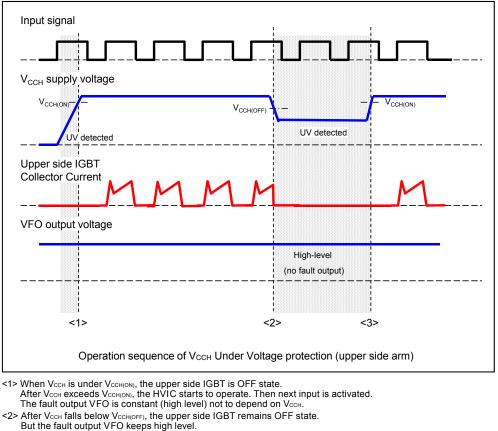
 2> The fault output VFO is activated when VccL falls below VccL(OFF), and all lower side IGBT remains OFF state.

When the voltage drop time is less than 20µs, the fault output pulse width is generated minimum 20µs and all lower side IGBTs are OFF state in spite of input signal condition during that time.

<3> UV is reset after tFo when VCCL exceeds VCCL(ON) and the fault output VFO is reset simultaneously.

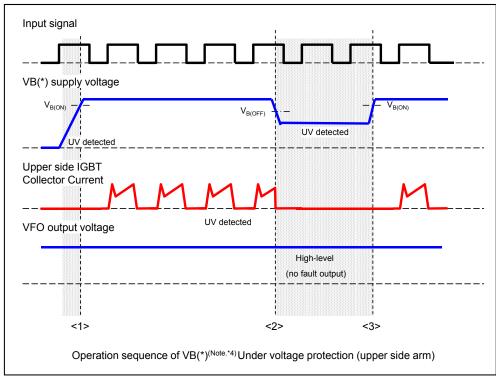
And the LVIC starts to operate, then next input is activated. <4> When the voltage drop time is more than t_{FO}, the fault output pulse width is generated and all lower side IGBTs are OFF state in spite of input signal condition during the same time.

Fig.2-4: Operation sequence of V_{CCH} Under voltage trip (upper side arm)



<3> The HVIC starts to operate after UV is reset, then next input is activated.





- <1> When VB(*) is under V_{B(ON)}, the upper side IGBT is OFF state. After VB(*) exceeds V_{B(ON)}, the HVIC starts to operate. Then next input is activated. The fault output VFO is constant (high level) not to depend on VB(*). (Note*14)
- After VB(*) falls below VB(OFF), the upper side IGBT remains OFF state.
 But the fault output VFO keeps high level. <2>

<3> The HVIC starts to operate after UV is reset, then next input is activated.

Note *14: The fault output is not given HVIC bias conditions.

WARNING

- 1. This Catalog contains the product specifications, characteristics, data, materials, and structures as of March 2016. The contents are subject to change without notice for specification changes or other reasons. When using a product listed in this Catalog, be sure to obtain the latest specifications.
- 2. All applications described in this Catalog exemplify the use of Fuji's products for your reference only. No right or license, either express or implied, under any patent, copyright, trade secret or other intellectual property right owned by Fuji Electric Co., Ltd. is (or shall be deemed) granted. Fuji Electric Co., Ltd. makes no representation or warranty, whether express or implied, relating to the infringement or alleged infringement of other's intellectual property rights which may arise from the use of the applications described herein.
- 3. Although Fuji Electric Co., Ltd. is enhancing product quality and reliability, a small percentage of semiconductor products may become faulty. When using Fuji Electric semiconductor products in your equipment, you are requested to take adequate safety measures to prevent the equipment from causing a physical injury, fire, or other problem if any of the products become faulty. It is recommended to make your design fail-safe, flame retardant, and free of malfunction.
- 4. The products introduced in this Catalog are intended for use in the following electronic and electrical equipment which has normal reliability requirements.
 - Computers OA equipment · Machine tools
- · Communications equipment (terminal devices) Electrical home appliances Personal equipment
- Measurement equipment Industrial robots etc.
- 5. If you need to use a product in this Catalog for equipment requiring higher reliability than normal, such as for the equipment listed below, it is imperative to contact Fuji Electric Co., Ltd. to obtain prior approval. When using these products for such equipment, take adequate measures such
 - as a backup system to prevent the equipment from malfunctioning even if a Fuji's product incorporated in the equipment becomes faulty. Trunk communications equipment

· Gas leakage detectors with an auto-shut-off feature

- Transportation equipment (mounted on cars and ships)
- Traffic-signal control equipment
- · Emergency equipment for responding to disasters and anti-burglary devices

Audiovisual equipment

- Medical equipment
- 6. Do not use products in this Catalog for the equipment requiring strict reliability such as the following and equivalents to strategic equipment (without
 - limitation).
 - Space equipment Aeronautic equipment Submarine repeater equipment
- Nuclear control equipment

· Safety devices

- 7. Copyright ©1996-2016 by Fuji Electric Co., Ltd. All rights reserved. No part of this Catalog may be reproduced in any form or by any means without the express permission of Fuji Electric Co., Ltd.
- 8. If you have any question about any portion in this Catalog, ask Fuji Electric Co., Ltd. or its sales agents before using the product. Neither Fuji Electric Co., Ltd. nor its agents shall be liable for any injury caused by any use of the products not in accordance with instructions set forth herein.



Innovating Energy Technology

Technical Information

IGBT Modules

- Please refer to URLs below for futher information about products, application manuals and technical documents.
- 关于本规格书中没有记载的产品信息,应用手册,技术资料等,请参考以下链接。
- ●本データシートに記載されていない製品情報,アプリケーションマニュアル,技術資料は以下の URL をご参照下さい。

FUJI ELECTRIC Power Semiconductor WEB site

日本	www.fujielectric.co.jp/products/semiconductor/
Global	www.fujielectric.com/products/semiconductor/
中国	www.fujielectric.com.cn/products/semiconductor/
Europe	www.fujielectric-europe.com/components/semiconductors/
North America	www.americas.fujielectric.com/components/semiconductors/

Information

日本	
1 半導体総合カタログ	www.fujielectric.co.jp/products/semiconductor/catalog/
2 製品情報	www.fujielectric.co.jp/products/semiconductor/model/
3 アプリケーションマニュアル	www.fujielectric.co.jp/products/semiconductor/model/igbt/application/
4 技術資料	www.fujielectric.co.jp/products/semiconductor/model/igbt/technical/
5 マウンティングインストラクション	www.fujielectric.co.jp/products/semiconductor/model/igbt/mounting/
6 IGBT 損失シミュレーションソフト	www.fujielectric.co.jp/products/semiconductor/model/igbt/simulation/
7 AT-NPC 3-Level 損失シュミレーションソフト	www.fujielectric.co.jp/products/semiconductor/model/igbt/simulation_3level/
8 富士電機技報	www.fujielectric.co.jp/products/semiconductor/journal/
9 製品のお問い合わせ	www.fujielectric.co.jp/products/semiconductor/contact/
10 改廃のお知らせ	www.fujielectric.co.jp/products/semiconductor/discontinued/

Global

1 Semiconductors General Catalog	www.fujielectric.com/products/semiconductor/catalog/
2 Product Information	www.fujielectric.com/products/semiconductor/model/
3 Application Manuals	www.fujielectric.com/products/semiconductor/model/igbt/application/
4 Technical Documents	www.fujielectric.com/products/semiconductor/model/igbt/technical/
5 Mounting Instructions	www.fujielectric.com/products/semiconductor/model/igbt/mounting/
6 IGBT Loss Simulation Software	www.fujielectric.com/products/semiconductor/model/igbt/simulation/
7 AT-NPC 3-Level Loss Simulation Software	www.fujielectric.com/products/semiconductor/model/igbt/simulation_3level/
8 Fuji Electric Journal	www.fujielectric.com/products/semiconductor/journal/
9 Contact	www.fujielectric.com/products/semiconductor/contact/
10 Revised and discontinued product information	www.fujielectric.com/products/semiconductor/discontinued/

中国

1 -	
1 半导体综合目录	www.fujielectric.com.cn/products/semiconductor/catalog/
2 产品信息	www.fujielectric.com.cn/products/semiconductor/model/
3 应用手册	www.fujielectric.com.cn/products/semiconductor/model/igbt/application/
4 技术资料	www.fujielectric.com.cn/products/semiconductor/model/igbt/technical/
5 安装说明书	www.fujielectric.com.cn/products/semiconductor/model/igbt/mounting/
6 IGBT 损耗模拟软件	www.fujielectric.com.cn/products/semiconductor/model/igbt/simulation/
7 AT-NPC 3-Level 损耗模拟软件	www.fujielectric.com.cn/products/semiconductor/model/igbt/simulation_3level/
8 富士电机技报	www.fujielectric.com.cn/products/semiconductor/journal/
9 产品咨询	www.fujielectric.com.cn/products/semiconductor/contact/
10 产品更改和停产信息	www.fujielectric.com.cn/products/semiconductor/discontinued/

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Fuji manufacturer:

Other Similar products are found below :

EW100AAG-3P100B EW50AAG-2P015B EW50RAGU-3P005K FMN-60 5V AH164-ZSWE3 AH165-EG33 AH165-J3C33A AH165-SGLW11E3 AH165-TGL5W11E3 AH165-TLO11H1 AHX511-L AR22E0L-10E4G AR22F0L-02H4R AR22G3R-01B AR22G4L-11E3A AR22JCR-3A14DC AR22M0R-01B AR22PR-311B AR22PR-711B AR22S2R-22W AR22V2L-11E3R AR22V3R-02RZ286 AR22VGE-11R AR30E0R-11G AR9T511-H AR9T511-M EG52F/40-30MA BLA005D BU-ECA2005L BW250EAGU-3P175 BW9FWCA-15A BZ6KL10CU 1TR0AK SA203CUL/125 SA203CUL/200 SA203RCUL/125 SC-E5-200V 2NC2F-CK SG103CUL/40-CO SK12LR-E01W AC09-CX0/11L1 EW125JAG-4P030K EW250JAGU-3P200K EW250JAGU-3P225K EW50EAG-3P050B EW50RAGU-3P003K ACX011-810 1JC0A0M01 AG23-LAE3-Y AH164-J2B22A